

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
ULN2002AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 70	ULN2002AN	Samples
ULN2002ANE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 70	ULN2002AN	Samples
ULN2003AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 70	ULN2003A	
ULN2003ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 70	ULN2003A	Samples
ULN2003ADRG3	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 70	ULN2003A	
ULN2003ADRG4	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 70	ULN2003A	
ULN2003ADYYR	ACTIVE	SOT-23-THIN	DYY	16	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 70	UN2003A	Samples
ULN2003AID	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 105	ULN2003AI	
ULN2003AIDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 105	ULN2003AI	Samples
ULN2003AIDRG4	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 105	ULN2003AI	
ULN2003AIN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	-40 to 105	ULN2003AIN	
ULN2003AINSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	ULN2003AI	Samples
ULN2003AIPW	OBSOLETE	TSSOP	PW	16		TBD	Call TI	Call TI	-40 to 105	UN2003AI	
ULN2003AIPWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 105	(U2003AI, UN2003AI)	Samples
ULN2003AIPWRG4	OBSOLETE	TSSOP	PW	16		TBD	Call TI	Call TI	-40 to 105	UN2003AI	
ULN2003AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU SN	N / A for Pkg Type	-40 to 70	ULN2003AN	Samples
ULN2003ANE4	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI	-40 to 70	ULN2003AN	
ULN2003ANS	OBSOLETE	SO	NS	16		TBD	Call TI	Call TI	-40 to 70	ULN2003A	
ULN2003ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 70	ULN2003A	Samples
ULN2003ANSRE4	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 70	ULN2003A	Samples
ULN2003ANSRG4	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 70	ULN2003A	Samples
ULN2003APW	OBSOLETE	TSSOP	PW	16		TBD	Call TI	Call TI	-40 to 70	UN2003A	
ULN2003APWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 70	UN2003A	Samples

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ULN2003APWRG4	OBSOLETE	TSSOP	PW	16		TBD	Call TI	Call TI	-40 to 70	UN2003A	
ULN2004AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-20 to 70	ULN2004A	
ULN2004ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-20 to 70	ULN2004A	Samples
ULN2004ADRG4	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-20 to 70	ULN2004A	
ULN2004AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 70	ULN2004AN	Samples
ULN2004ANE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-20 to 70	ULN2004AN	Samples
ULN2004ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-20 to 70	ULN2004A	Samples
ULQ2003AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 85	ULQ2003A	
ULQ2003ADG4	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI		ULQ2003A	
ULQ2003ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	-40 to 85	ULQ2003A	
ULQ2003ADRG4	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI		ULQ2003A	
ULQ2003AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	ULQ2003A	Samples
ULQ2004AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ULQ2004A	Samples
ULQ2004ADG4	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		ULQ2004A	Samples
ULQ2004ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ULQ2004A	Samples
ULQ2004ADRG4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		ULQ2004A	Samples
ULQ2004AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	ULQ2004AN	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

- (3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF ULQ2003A, ULQ2004A :

- Automotive : [ULQ2003A-Q1](#), [ULQ2004A-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects